

MOS INTEGRATED CIRCUIT $\mu PD4990A$

SERIAL I/O CALENDAR & CLOCK CMOS LSI

The μ PD4990A is a CMOS LSI developed to input/output calendar & clock data serially to/from the micro computer. The crystal frequency is 32.768 kHz and the data items included are time, minute, second, year, month, day, and week.

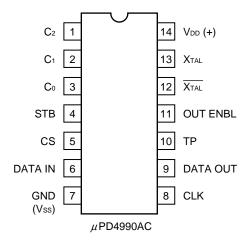
FEATURES

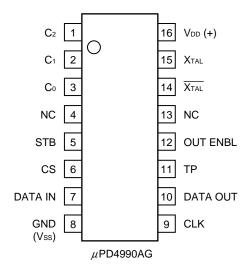
- Built-in counters for time (hour, minute, and second) and date (year, month, day, and week)
- · Leap years are adjusted automatically.
- Data is represented in BCD notation (except months in hexadecimal notation) and input/output serially.
- · Commands can be set by inputting serial data.
- Selective timing pulses (TPs) are 64 Hz, 256 Hz, 2 048 Hz, and 4 096 Hz and selective output intervals are 1, 10, 30, and 60 seconds.

ORDERING INFORMATION

PART No.	PACKAGE
μPD4990AC	14-pin plastic DIP (300 mil)
μPD4990AG	16-pin plastic SOP (300 mil)

CONNECTION DIAGRAM (Top View)





NC: NO CONNECTION



ABSOLUTE MAXIMUM RATINGS

Supply Voltage	$V_{DD} - V_{SS}$	−0.5 to 7.0	V
Input Voltage	Vin	Vss -0.3 to Vpp $+0.3$	V
Operating Temperature Range	Topt	-40 to +85	°C
Storage Temperature Range	Tstg	-65 to +125	°C
Output Terminal Voltage	Vouт	-0.5 to 7.0	V

ELECTRICAL CHARACTERISTICS (f = 32.768 kHz, Cg = CD = 20 pF, Cl = 20 k Ω , Ta = 25 °C)

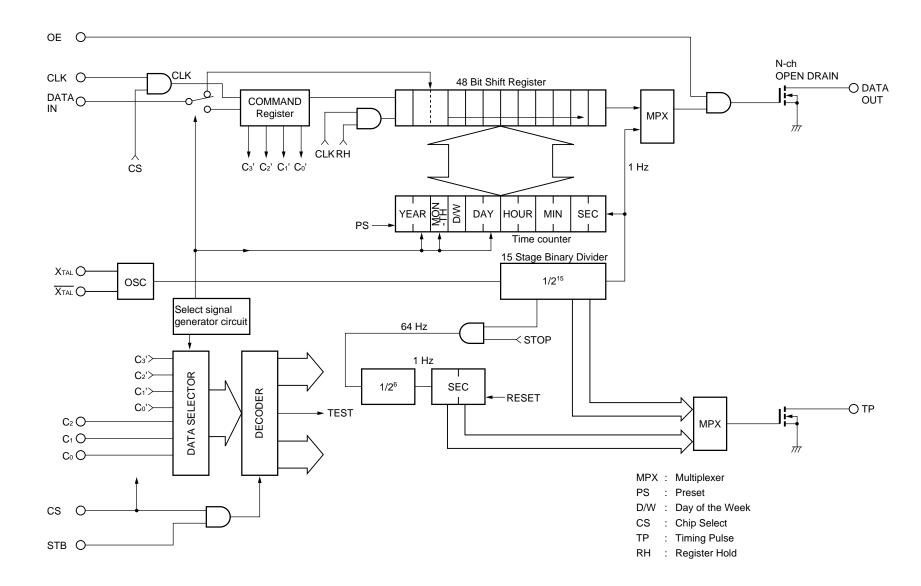
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Operating Voltage	V _{DD} - Vss	2.00		5.50	V	
Current Consumption	IDD		8	20	μΑ	V _{DD} - V _{SS} = 3.60 V
Current Consumption	IDD			100	μΑ	V _{DD} - V _{SS} = 5.50 V
Low Level Output Voltage	Vol			0.4*	0.4* V	V _{DD} – V _{SS} = 2.0 to 5.5 V
Low Level Output Voltage						IoL = 500 μA
CLK Input Frequency	fcLK	DC		500	kHz	V _{DD} – V _{SS} = 2.0 V, Duty 50 %
Input Leakage Current	lin			±1	μΑ	V _{DD} - V _{SS} = 5.50 V
High Level Input Voltage	ViH	0.7 V _{DD}		V _{DD}	٧	
Low Level Input Voltage	Vıl	Vss		0.3 V _{DD}	٧	

^{*} TP and DATA OUT are N-channel open drain output.

A.C. ELECTRICAL CHARACTERISTICS (f = 32.768 kHz, VDD - VSS = 2.0 V, $Ta = 25 \, ^{\circ}C$)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
C _{0 to 2} , CS – STB Set-up Time	t su	1			μs	
STB Pulse Width	tsтв	1			μs	
C _{0 to 2} , CS – STB Hold Time	t HLD	1			μs	
STB LATCH Delay Time	t _{d1}			1**	μs	except Time Read mode
CLK-DATA OUT Delay time	t _{d(c-o)}			1	μs	R_L = 33 kΩ, C_L = 15 pF
DATA IN Set-up Time	tosu	1			μs	
DATA IN Hold Time	t DHLD	1			μs	

^{**} **Note:** When a function mode is Time Read mode (other than Test mode), STB LATCH delay time is 20 μ s MAX. (t_{d2}).





FUNCTION SPECIFICATIONS

- Crystal frequency (X tal osc.).
 - o 32.768 kHz

Data

Data types are: second, minute, day, week, month, and year.

Leap years, 31-day months, and months with 30 or less days are adjusted automatically.

A 24-hour system is used and last two digits of Gregorian year are indicated.

It is assumed that leap years are expressed by multiples of 4.

Data format

Data is represented in BCD notation. Only months are represented in hexadecimal notation.

Data input-output and Clock

Data is input/output synchronously with reference to the external clocks input from the CLK pin using the serial input/output system. (See Fig. 1.)

• Timing pulse output

Three frequencies, 64 Hz, 256 Hz, and 2 048 Hz, can be set with C₀, C₁ and C₂ pins.

Using serial data input command, selective timing pulses (TPs) are 64 Hz, 256 Hz, 2 048 Hz, and 4 096 Hz and selective output intervals are 1, 10, 30, and 60 seconds.

Function mode selection

A function mode can be selected by the inputs from C_0 , C_1 , and C_2 . Also a function mode can be selected through serial data input. ($C_0 = C_1 = C_2 = V_{DD}$)

Each command is latched with STB (strobe).

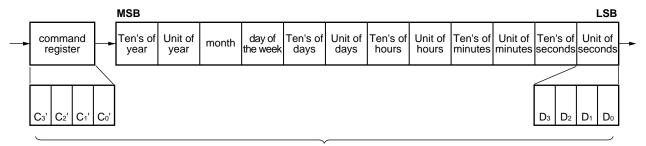
Chip select

Connecting the CS pin to the ground level inhibits CLK and STB inputs.

Data output inhibition

Connecting the OUT ENBL pin to the ground level sets the DATA OUT pin at high impedance.

Figure 1.



52 Bit Shift Register

^{*} DATA of 52 Bit Shift Register appears on DATA OUT terminal from LSB of second.



TERMINALS

• Input terminals

DATA IN Data input of 40-/52-bit shift register
 CLK Shift clock input of 40-/52-bit shift register

o Co, C1, C2 Command input (3 bit)

o STB Strobe input

• CS Chip select input (Prohibits CLK & STB)

o OUT ENBL Output control input (Makes the DATA OUT high impedance by inputting low level).

• Output terminals (N-channel Open Drain)

o DATA OUT Data output of 40-/52-bit shift register

• TP Timing pulse output

• Oscillation terminals

XTAL Oscillation inverter input (OSC IN)
 XTAL Oscillation inverter output (OSC OUT)

• Power supply terminals

VDD Plus power supplyGND (Vss) Common line



COMMAND SPECIFICATIONS

Commands input from C₀, C₁, and C₂ pins (1 ...H, 0 ...L)
 Shift register 40 bit (The year function is ineffective.)
 (Operates as the existing μPD1990AC in other than test mode)

C ₂	C ₁	Co		FUNCTION
0	0	0	Register Hold	DATA OUT = 1 Hz
0	0	1	Register Shift	DATA OUT = [LSB] = 0 or 1
0	1	0	Time Set & Counter Hold	DATA OUT = [LSB] = 0 or 1
0	1	1	Time Read	DATA OUT = 1 Hz
1	0	0	TP = 64 Hz	
1	0	1	TP = 256 Hz	
1	1	0	TP = 2 048 Hz	
1	1	1	Serial command transfer mo	ode

^{*} The test mode is cancelled by [C2, C1, C0] = [0, 0, 0] to [1, 1, 0].

o Serial data commands

Set $[C_2, C_1, C_0] = [1, 1, 1]$ at all time.

Shift register 52 bit (The year function is effective.)

Сз'	C ₂ '	C ₁ '	Co'	FU	INCTION		
0	0	0	0	Register Hold	DATA OUT = 1 Hz		
0	0	0	1	Register Shift	DATA OUT = [LSB] = 0 or 1		
0	0	1	0	Time Set & Counter Hold	DATA OUT = [LSB] = 0 or 1		
0	0	1	1	Time Read	DATA OUT = 1 Hz		
0	1	0	0	TP = 64 Hz			
0	1	0	1	TP = 256 Hz			
0	1	1	0	TP = 2 048 Hz			
0	1	1	1	TP = 4 096 Hz			
1	0	0	0	TP = 1 s interval set (counter reset & start)			
1	0	0	1	TP = 10 s interval set (counter reset & start)			
1	0	1	0	TP = 30 s interval set (counter reset & start)			
1	0	1	1	TP = 60 s interval set (counter reset & start)			
1	1	0	0	Interval Output Flag Reset			
1	1	0	1	Interval Timer Clock Run			
1	1	1	0	Interval Timer Clock Stop			
1	1	1	1	TEST MODE SET			

When serial data commands are used, C_0 , C_1 , and C_2 pins should be connected V_{DD} pin.

- Command input
 - (1) 3-bit binary code input: C2, C1, C0
 - (2) 4-bit serial transfer command input: C3', C2', C1', C0'
- Number of commands

	C ₂ , C ₁ , C ₀	C'3, C'2, C'1, C'0
Register control	4	4
TP select	3	8
TP control	0	3
Test mode set	1	1

- Commands (C₃', C₂', C₁', C₀' commands are made effective only when [C₂, C₁, C₀] = [1, 1, 1].)
 - (1) Register control

$$[C_2, C_1, C_0] / [C_3', C_2', C_1', C_0']$$

• Register Hold Mode

[C₂, C₁, C₀]

The 40-bit shift register is held. The year function is ineffective.

The 48-bit shift register is held.

The command register is not held.

- * The DATA OUT output frequency is 1 Hz.
- Register Shift Mode

[C₂, C₁, C₀]

The 40-bit shift register data can be shifted. The year function is ineffective.

Data in 52-bit shift registers (including command registers) can be shifted. For command register, data can be always shifted using the serial command transfer mode.

- * The DATA OUT output is LSB data from the shift register.
- o Time Set and Counter Hold Mode

[C₂, C₁, C₀]

 $\label{eq:definition} \mbox{Data is transferred from the 40-bit shift register to the time counter. \ \ The year function is ineffective.}$

[C₃', C₂', C₁', C₀']

Data is transferred from the 48-bit shift register to the time counter.

- * This command is used to reset the last 10-15 of 15 Stage Binary Divider and holds the time counter.
 - 15 Stage Binary Divider resetting and time counter release are executed by the following:

$$[C2, C1, C0] = [0, 0, 0] [0, 0, 1] [0, 1, 1] [C3', C2', C1', C0'] = [0, 0, 0, 0] [0, 0, 0, 1] [0, 0, 1, 1]$$

The time setting accuracy is ± 15.625 ms.

The DATA OUT pin outputs LSB data (0 or 1) from the shift register.

After this command is executed, the 40-/48-bit shift register is held and data cannot be shifted.

• Time Read Mode [0, 1, 1]

[C₂, C₁, C₀]

Data is transferred from the time-counter to the 40-bit shift register. The year function is ineffective.

 $[C_3', C_2', C_1', C_0']$

Data is transferred from the time counter to the 48-bit shift register.

* The DATA OUT pin output is a 1 Hz frequency.

After this command is executed, the 40-/48-bit shift register is held and data cannot be shifted.



- (2) TP selection and control [C₂, C₁, C₀] / [C₃', C₂', C₁', C₀']
 - TP = 64 Hz Set Mode [1, 0, 0] / [0, 1, 0, 0]

64 Hz (50 % duty) is output to the TP pin.

[C₂, C₁, C₀]: The year function is ineffective and the interval timer stops.

• <u>TP = 256 Hz</u> Set Mode [1, 0, 1] / [0, 1, 0, 1]

256 Hz (50 % duty) is output to the TP pin.

[C2, C1, C0]: The year function is ineffective and the interval timer stops.

• <u>TP = 2 048 Hz</u> Set Mode [1, 1, 0] / [0, 1, 1, 0]

2 048 Hz (50 % duty) is output to the TP pin.

[C₂, C₁, C₀]: The year function is ineffective and the interval timer stops.

Modes permitted only for serial commands [C₃', C₂', C₁', C₀']

• TP = 4 098 Hz Set Mode [0, 1, 1, 1]

4 098 Hz (50 % duty) is output to the TP pin. The interval timer stops.

• **TP = 1-second** Interval Set Mode (counter reset & start) [1, 0, 0, 0]

A 1-second interval signal is output to the TP pin.

• <u>TP = 10-second</u> Interval Set Mode (counter reset & start) [1, 0, 0, 1]

A 10-second interval signal is output to the TP pin.

• TP = 30-second Interval Set Mode (counter reset & start) [1, 0, 1, 0]

A 30-second interval signal is output to the TP pin.

• TP = 60-second Interval Set Mode (counter reset & start) [1, 0, 1, 1]

A 60-second interval signal is output to the TP pin.

• Interval Output Flag Reset [1, 1, 0, 0]

The interval signal output to the TP pin is reset.

The interval timer counter continue the operation.

• Interval Timer Clock Run [1, 1, 0, 1]

The timer for outputting interval signals is reset then started.

• Interval Timer Clock Stop [1, 1, 1, 0]

The timer for outputting interval signals stops.

The output status does not change.

(3) Serial command transfer mode setting

Set
$$[C_2, C_1, C_0] = [1, 1, 1]$$

(4) Test mode setting

$$Set \; [C_2,\; C_1,\; C_0] = [1,\; 1,\; 1] \; [C_3',\; C_2',\; C_1',\; C_0'] = [1,\; 1,\; 1,\; 1]$$

o 3-bit parallel command setting mode [C2, C1, C0]

The year function is ineffective when commands are input through C2, C1, and C0 pins.

Generally, February involves 28 days. The 29th day can be set optionally. The next day of the February 29th can be set the March 1st automatically. The interval timer is in the halt state.

- * The test mode is cancelled by $[C_2, C_1, C_0] = [0, 0, 0]$ to [1, 1, 0].
- Serial command transfer mode [C₃', C₂', C₁', C₀']

If a strobe signal is input with C_2 , C_1 , and C_0 pins set at the V_{DD} level ([1, 1, 1]), the contents of the serial command register ([C_3 ', C_2 ', C_1 ', C_0 ']) are received as a command; the year function is effective.

* The test mode is cancelled by [C₃', C₂', C₁', C₀']

$$= [0, 0, 0]$$

$$= [0, 1, 0, 0]$$
 to $[1, 1, 1, 0]$

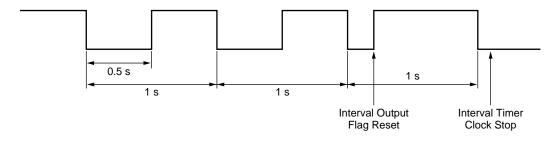
In this mode, the serial command register is not held with the Register Hold command. Accordingly, the serial command can be executed irrespective of the mode if the CS pin is active.

The year function is effective in the serial command transfer mode.

Interval output function

An interrupt signal can be output by selecting an output from TP.

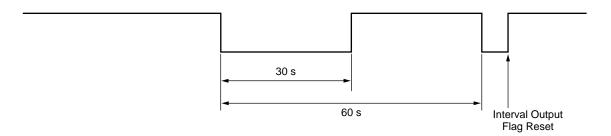
Interrupt signals are output repeatedly at specified intervals until their output is suppressed by a command. Only output flags can be reset to operate the timer continuously.



Interval of 1 second

The interval signal waveform is rectangular (50 % duty) if not reset.

The interval timer is independent of the Timer Counter, so it is not affected by the resetting of the current time timer.



The interval timer accuracy is ± 15.625 ms.

* The interval timer counter is reset by [1, 0, 0, 0] through [1, 0, 1, 1].



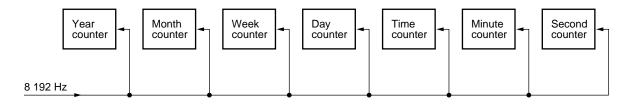
o Test mode

In the test mode, data is output to the DATA OUT pin regardless of whether data has been input to OUT ENBL.

There are two different test modes depending on the OUT ENBL data.

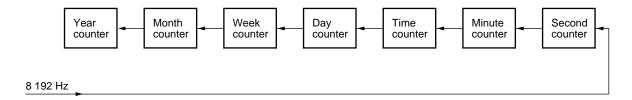
(1) Test mode 1 (OUT ENBL = 0)

8 192 Hz signals are set parallel in the counters for year, month, week, day, time, minute, and second. There is no carry from these counters.



(2) Test mode 2 (OUT ENBL = 1)

A 8 192 Hz signal is input to the second counter instead of the 1 Hz signal. There is carry from counters.



Outputs from DATA OUT and TP OUT pins in different function modes are listed below.

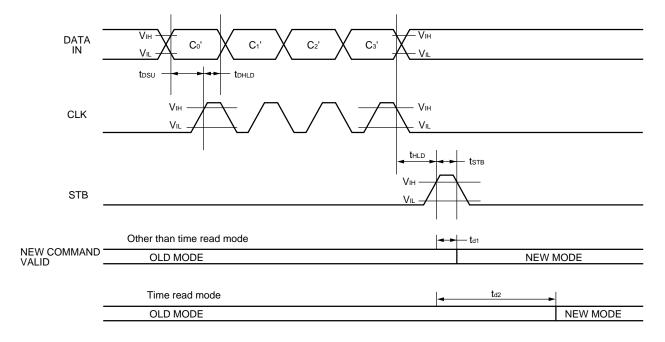
MODE	DATA OUT TP Others		Others	
REGISTER HOLD	1 Hz	64 Hz	By this comman	d, TEST MODE is released.
REGISTER SHIFT	LSB of shift register	32 Hz		8 192 Hz input to time counter
TIME SET	LSB of shift register	L Level	Test mode	
TIME READ	1 Hz	32 Hz		8 192 Hz input to time counter

When the REGISTER HOLD command cancels the test mode, 64 Hz is output to the TP pin.



TIMING DIAGRAM FOR SETTING COMMANDS (Co', C1', C2', C3')

Figure 2.



$$V_{DD}-V_{SS}=2.0~V~t_{DSU}=1~\mu s~MIN.$$

$$t_{DHLD}=1~\mu s~MIN.$$

$$t_{HLD}=1~\mu s~MIN.$$

$$t_{STB}=1~\mu s~MIN.$$

$$t_{d1}=1~\mu s~MAX.~(Other~than~time~read~mode)$$

$$t_{d2}=20~\mu s~MAX.~(Time~read~mode)$$

Note: Command (C2, C1, C0) is set to (1, 1, 1)

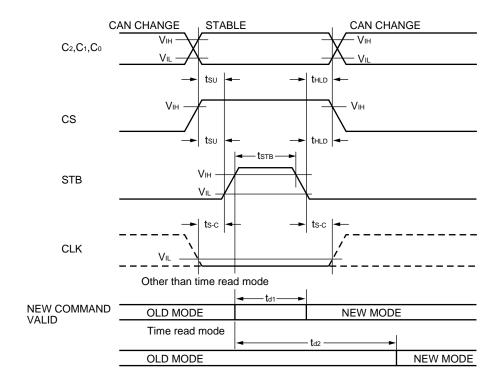
CS = "H"

A mode is latched by STB and held until another mode in the same group is set.



TIMING DIAGRAM FOR SETTING COMMANDS (Co, C1, C2)

Figure 3.

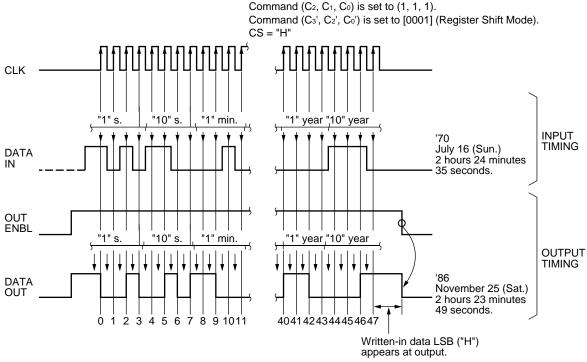


Note: A mode is latched by STB and held until another mode in the same group is set.



DATA INPUT/OUTPUT TIMING DIAGRAM

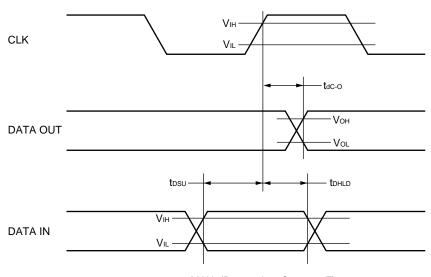
Figure 4.



Note: Reading-in timing of CPU (Trailing edge of CLK).

TIMING DIAGRAM OF DATA INPUT AND OUTPUT

Figure 5.

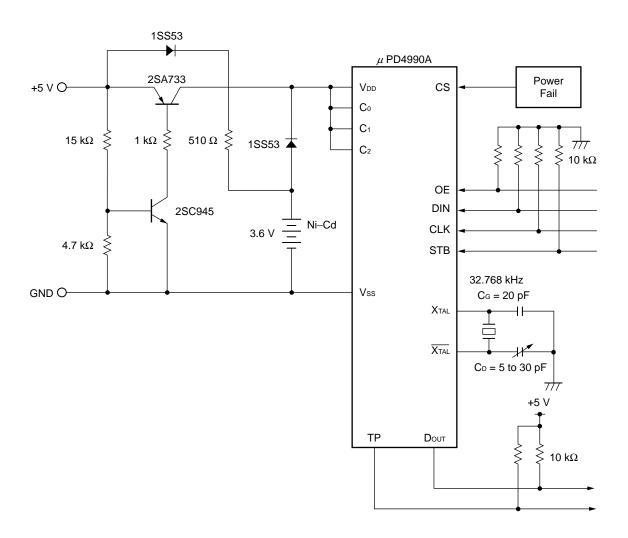


t_{dC-O} : $1 \mu s$ MAX. (R_L = 33 k Ω , C_L = 25 pF)

tosu : $1 \mu s$ MIN. tohlo : $1 \mu s$ MIN.

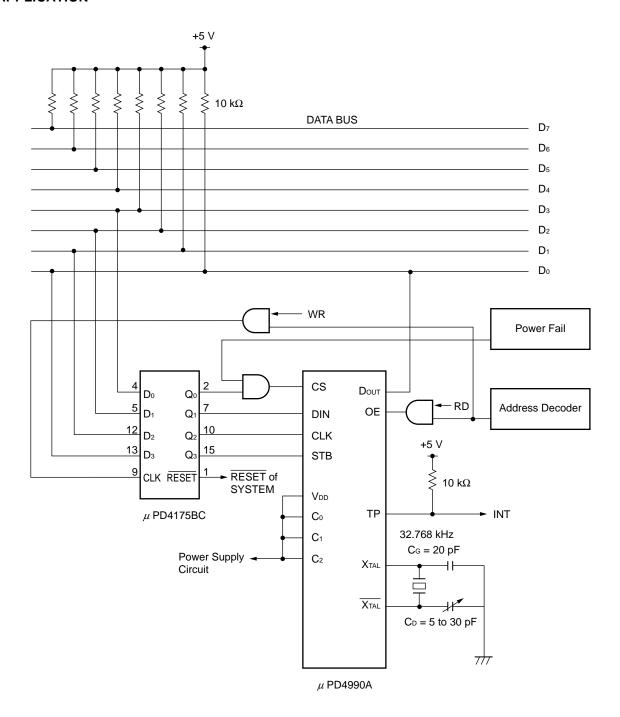


POWER SUPPLY CIRCUIT



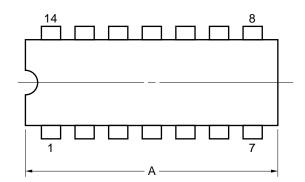


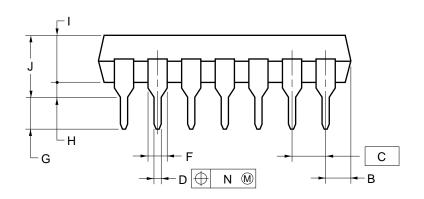
APPLICATION

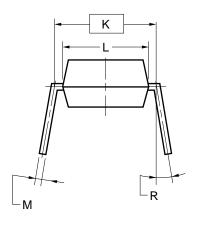




14PIN PLASTIC DIP (300 mil)







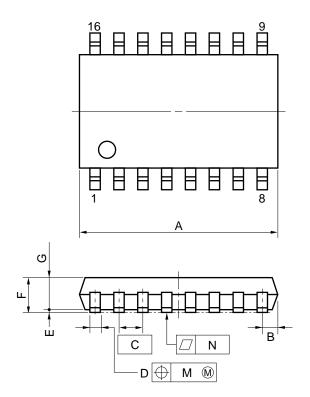
NOTES

- 1) Each lead centerline is located within 0.25 mm (0.01 inch) of its true position (T.P.) at maximum material condition.
- 2) Item "K" to center of leads when formed parallel.

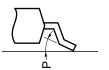
ITEM	MILLIMETERS	INCHES
Α	20.32 MAX.	0.800 MAX.
В	2.54 MAX.	0.100 MAX.
С	2.54 (T.P.)	0.100 (T.P.)
D	0.50±0.10	$0.020^{+0.004}_{-0.005}$
F	1.2 MIN.	0.047 MIN.
G	3.5±0.3	0.138±0.012
Н	0.51 MIN.	0.020 MIN.
1	4.31 MAX.	0.170 MAX.
J	5.08 MAX.	0.200 MAX.
K	7.62 (T.P.)	0.300 (T.P.)
L	6.4	0.252
М	$0.25^{+0.10}_{-0.05}$	$0.010^{+0.004}_{-0.003}$
N	0.25	0.01
R	0~15°	0~15°

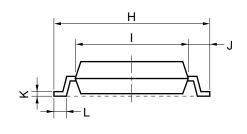
P14C-100-300A,C-1

16 PIN PLASTIC SOP (300 mil)



detail of lead end





NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS	INCHES
IIEW		
A	10.46 MAX.	0.412 MAX.
В	0.78 MAX.	0.031 MAX.
С	1.27 (T.P.)	0.050 (T.P.)
D	$0.40^{+0.10}_{-0.05}$	$0.016^{+0.004}_{-0.003}$
E	0.1±0.1	0.004±0.004
F	1.8 MAX.	0.071 MAX.
G	1.55	0.061
Н	7.7±0.3	0.303±0.012
- 1	5.6	0.220
J	1.1	0.043
K	$0.20^{+0.10}_{-0.05}$	$0.008^{+0.004}_{-0.002}$
L	0.6±0.2	$0.024^{+0.008}_{-0.009}$
М	0.12	0.005
N	0.10	0.004
Р	3°+7°	3°+7°

P16GM-50-300B-4

[MEMO]

NEC μ PD4990A

[MEMO]

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